DAMA GROUP SCHOLARSHIP PROGRAM CHECK LIST

Full Name of Applicant (as per I/C):	
Contact No (House):	_
(H/P):	
Email Address :	

Please attach this CHECKLIST as the front page together with other documents in the following order :

- Scholarship Application Form
- Supporting Documents Listed As Follow:

Have you submitted the following documents? Please tick ($\sqrt{}$)

(√)

1	Application Form	
2	Identity Card photocopy	
3	School Leaving Certificates photocopy	
4	School Testimonials photocopy	
5	University Acceptance / Offer Letter photocopy	
6	Academic Calendar (for the degree courses) photocopy	
7	Statement of Course Fees from Bursar of University photocopy	
8	Academic result (Photocopy):	
	*A.) University Academic Result (Only applicable for first year student)	
	B.) SPM/ SPMV	
	C.) STPM/ Matriculation/ 'A' Level/ UEC/ Foundation/ 'O' Level	
	D.) MUET/IELTS/1119/TOEFL	
9	Parents' Identity Card photocopy	
10	Parents' proof of income for the past 2 years - Tax Assessment / EA photocopy	
11	Parents' Salary Slip for the past 3 months photocopy	
12	Disability Card / OKU Card photocopy (if available)	
13	Disability Card / OKU Card - Physically Challenged Family Member photocopy (if available)	
14	Letter from Principle/ Faculty Dean/ Department of Student Affairs certifying that the applicant is not holding any	
	scholarship / grant / loan from other sources	
15	Certificates of Co-Curriculum Activities photocopy	
16	Others (if any)	
	Please state:	
17	All the certificates are certified by Principle/ Faculty Dean/ Department of Student Affairs	

Kindly ensure all required documents are attached.

Incomplete documents submission might not be processed.



DAIKIN MALAYSIA GROUP SCHOLARSHIP PROGRAM APPLICATION FORM

DAG	CCDA	TOF	SIZE	DIL	$\alpha T \alpha$
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			Persona	al Detail	S				
Full Name (as per IC)			NRIC No.			Date of Birth			
Age			Marital Status	Gender					
Nationality	Nationality					Religion			
Mobile No	Mobile No Home Tel No					Email Address			
Residential Address		Pos	st code:	State:					
77.4.4.4.6.77			Tertiary Edi	ucation D	etails				
University / College Course Name Course Duration	e Name	:							
			Family	Details					
2	Fa	ther		Mother					
Full Name			Full Name						
(as per IC) NRIC No.					(as per IC) NRIC No.				
Age				Age					
Residential Address	Post c	ode: St	ate:	Residential Address		Post code:State:			
House Phone No				House Phone No					
Mobile No				Mobile No					
Occupation				Occupati	on				
Working Status	Working Full Time	Not Working Part Time	Retired	Working Status		Working Not Working Full Time Part			
Name of Employer				Name of	Employer				
Address of Employer	Telephone No Fax No			Address	of Employer	Telephone No Fax no			
3 (a) Household In	come Per Mon	th :RM							
3(b) Annual Gross	Income of Parei	nts (Latest Year	·)						
	Father (RM)			N	Iother (RM)	Total (RM)			
Employment									
Business									
Rental									
Others	tal						 		

		Types	of Expen	diture				Monthly (RM	1)	
	House Installment									
	Food									
	Electricity / Water									
	Telephone									
	Loan Repayment (car / moto	r-bike / ap	pliances / et	c)					
	Transportation									
	Education									
	Others (Please spe	ecify)								
			Total							
					Si	blings Info	rmation			
	Full Name	Age	Gender	Relatio	nship	Marital Status	Occupation / Grade (if Study)	Company / Schoo Institution	1/	Monthly Income (if working)
_										
_										
								_		
	a) Has/have any of yb) If YES, please state			rently/prev	iously re	ceived any	Scholarship?	Y	Zes	No L
				:	Siblings'	Scholarshi	ip Information			
	Full Name			Organizati stitution	ion /	Cou	ırse Name	Total Amount Per	Annum	Course Duration (Years)
_										
h	ysically Challenged Fa	amily Mer	nbers (disa	bility, disea	ses, impa	airs, etc) - IF	FANY		1	

Full Name	Age	Relationship	Illness/Impairs	Duration

7 Do you have any siblings / relatives who are serving under Daikin Malaysia Group? If yes, please give the details:									
		Name (as per IC)	Contact No.	Relationship	Name o	of Company	Position	Years of services	
			Extra Camionlan A	ativities (Second	owr Cabac	ol Onwords)			
		T	Extra-Curricular A	tcuvities (Second	ary School	of Onwards)			
8	No	Associations / Soc	ieties / Club / Sport	From (Y	ear)	To (Year)	Posit	ion Held	
	2								
	3								
	4								
	5								
**	Pleas	e do not state position held i							
ı			Awards (Secondary Schoo	l Onward	ls)			
9	No	Award(s)	and Details	7	Year			Levels / Grade	
	2								
	3								
	4								
	5								
				Medical Condition	ons				
10	10(a)		sight, hearing, speech)? e state:						
	10(b)	NO Please quote Disabled (OKU)) Identification Card numbe	r (where applicable)	:				
		Disabled (OKU) Identification		, ,					
	10(c)	Any previous illness / surgery			•				
		YES Pleas	e state:		ı				
	10(d)	Any current illness?							
		YES Pleas	e state:						
			V	Working Experie	nce				
11		Name of Company	Position	Date Joined From To	Last D	rawn Salary	Reason o	f leaving	
			1	10					
Į.			L	1	1				

Referees **NOTE: NOT YOUR RELATIVES. PREFERABLY YOUR LECTURER(S) / TEACHER(S)

 ${\bf 12} \ \ Give \ {\bf TWO} \ referees \ that \ are \ not \ related \ to \ you, \ who \ may \ attest \ to \ your \ achievements \ and \ qualifications:$

	No	Name	Contact No.	Employer Na	ame	Occupation	Relationship	No of Years Know
	1							
	2							
			Ot	hers				
13	13(a)	Were you a scholarship recipient before?					YES	NO
	13(b)	Are you RECEIVING any financial assistance	e or sponsorship from	other organiza	tion, in:	stitution, fund	VPC.	1 20
		or foundation?					YES	NO
		If YES, please give details: Institution/Fund/Organization/Found	ation (e.g. JPA, MA)	RA. Dur	ation o	of Sponsorship	Amount Per	Bond Period
		PETRONAS, PTPT		Fre	om	То	Annum (RM)	(if any)
		1)						
		2)						
		3)						
	13(c)	Are you currently APPLYING any financial a foundation?	assistance or sponsors	hip from other of	organiz	ation, institution,	fund or YES	NO
		If YES, please give details:		l n		66 11	Amount Per	
		Institution/Fund/Organization/Found PETRONAS, PTPT	мл,		of Sponsorship	Annum	Bond Period (if any)	
		1)	., ,	FF	om	То	(RM)	, ,
		2)						
		3)						
	13(d)	Have you applied for Daikin Malaysia Group	scholarship before?				YES	NO
	13(e)	Were you the recipient of the Daikin Malaysia	Group scholarship be	efore?			YES	NO
	13(f)	Are you willing to serve an employment bond successful completion of studies?	within any subsidiari	es of Daikin Ma	ılaysia (Group upon	YES	NO
	13(g)	Are you willing to be an intern student under	any subsidiaries of Da	iikin Malaysia C	Group d	uring semester bi	reak? YES	NO
				planation				
14	Tell u	as why are you interested in getting the Daikin	Scholarship? (in not n	nore than 100 w	ords)			
	L							

Declaration

15 Dec	5 Declaration of School / College / University						
	15(a) I hereby confirm that the applicant as mentioned above has given the correct and accurate information.15(b) I hereby confirm that the applicant is our school student.						
	NAME	SIGNATURE	School / College /				
	Principal / Faculty Dean / Dept of Student Affairs	Principal / Faculty Dean / Dept of Student Affairs	University Stamp				
16 Dec	claration of Applicant						
info sch	I, hereby declare that the information given in this application form is complete, true and accurate. I understand that any information given falsely or withheld will affect the decision of my application, and may result in my ineligibility for the scholarship award. I understand that any misrepresentation of facts herein will be sufficient cause for the company to terminate scholarship received by me.						
	Name: IC No: Date:						
	OFFICE USE ONLY						
	Reference No :						
	Rejected : YES NO Shortlisted : YES NO						
	Date of Interview :						
	Awarded : YES NO						